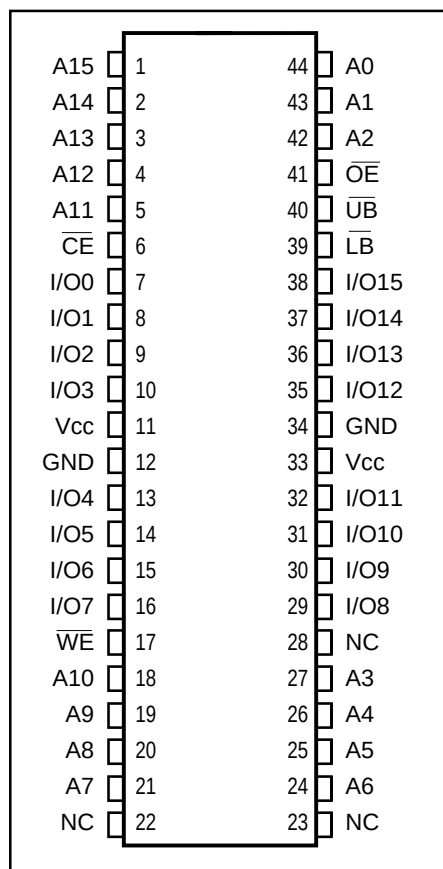
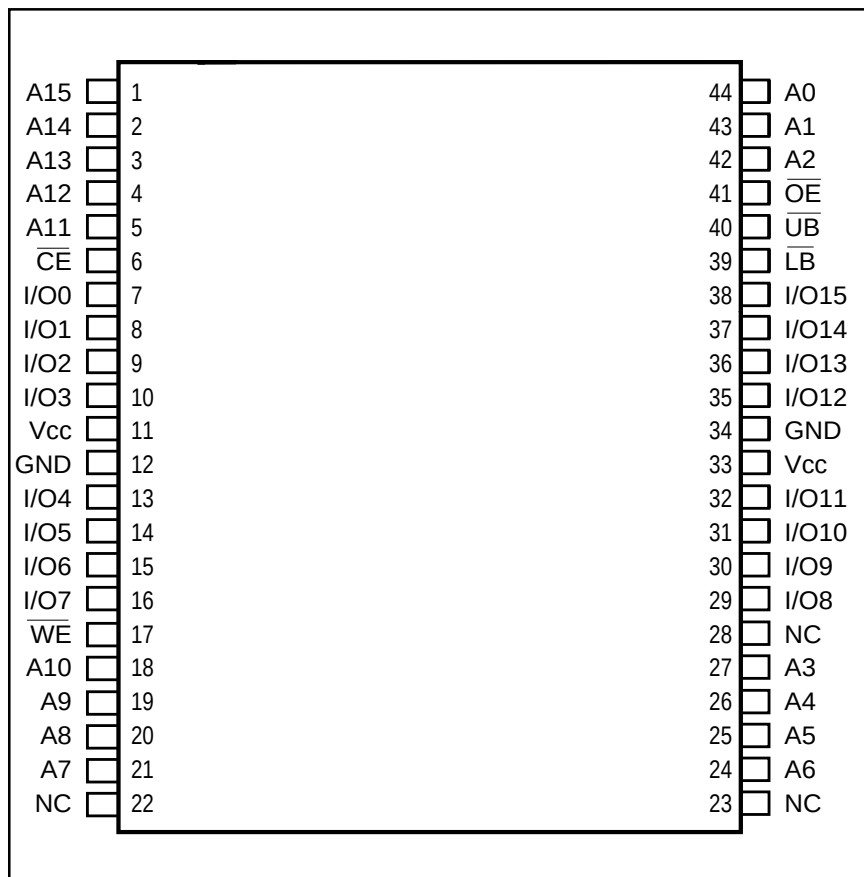


PIN CONFIGURATIONS

44-Pin SOJ



44-Pin TSOP (Type II)



PIN DESCRIPTIONS

A0-A15	Address Inputs
I/O0-I/O15	Data Inputs/Outputs
$\overline{CE}$	Chip Enable Input
$\overline{OE}$	Output Enable Input
$\overline{WE}$	Write Enable Input

$\overline{LB}$	Lower-byte Control (I/O0-I/O7)
$\overline{UB}$	Upper-byte Control (I/O8-I/O15)
NC	No Connection
Vcc	Power
GND	Ground

TRUTH TABLE

Mode	I/O PIN						Vcc Current	
	$\overline{WE}$	$\overline{CE}$	$\overline{OE}$	$\overline{LB}$	$\overline{UB}$	I/O0-I/O7		I/O8-I/O15
Not Selected	X	H	X	X	X	High-Z	High-Z	Isb1, Isb2
Output Disabled	H	L	H	X	X	High-Z	High-Z	Icc1, Icc2
	X	L	X	H	H	High-Z	High-Z	
Read	H	L	L	L	H	DOUT	High-Z	Icc1, Icc2
	H	L	L	H	L	High-Z	DOUT	
	H	L	L	L	L	DOUT	DOUT	
Write	L	L	X	L	H	DIN	High-Z	Icc1, Icc2
	L	L	X	H	L	High-Z	DIN	
	L	L	X	L	L	DIN	DIN	

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Parameter	Value	Unit
V _{TERM}	Terminal Voltage with Respect to GND	−0.5 to +7.0	V
T _{STG}	Storage Temperature	−65 to +150	°C
P _T	Power Dissipation	1.5	W
I _{OUT}	DC Output Current (LOW)	20	mA

Note:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

OPERATING RANGE

Range	Ambient Temperature	Speed	V _{CC}
Commercial	0°C to +70°C	−10, −12	5V ± 5%
		−15, −20	5V ± 10%
Industrial	−40°C to +85°C	−12	5V ± 5%
		−15, −20	5V ± 10%

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = −4.0 mA I _{OH} = −100 μA	2.4 —	— 3.95	V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA	—	0.4	V
V _{IH}	Input HIGH Voltage		2.2	V _{CC} + 0.5	V
V _{IL}	Input LOW Voltage ⁽¹⁾		−0.5	0.8	V
I _{LI}	Input Leakage	GND ≤ V _{IN} ≤ V _{CC}	−2	2	μA
I _{LO}	Output Leakage	GND ≤ V _{OUT} ≤ V _{CC} , Outputs Disabled	−2	2	μA

Notes:

1. V_{IL} (min.) = −3.0V for pulse width less than 10 ns.

POWER SUPPLY CHARACTERISTICS⁽¹⁾ (Over Operating Range)

Symbol	Parameter	Test Conditions	−10		−12		−15		−20		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
I _{CC}	V _{CC} Dynamic Operating Supply Current	V _{CC} = Max., I _{OUT} = 0 mA, f = MAX	Com.	— 300	— 280	— 300	— 260	— 290	— 235	— 255	mA
I _{SB1}	TTL Standby Current (TTL Inputs)	V _{CC} = Max., V _{IN} = V _{IH} or V _{IL} CE ≥ V _{IH} , f = max	Com.	— 50	— 50	— 55	— 50	— 55	— 50	— 55	mA
I _{SB2}	CMOS Standby Current (CMOS Inputs)	V _{CC} = Max., CE ≥ V _{CC} − 0.2V, V _{IN} ≥ V _{CC} − 0.2V, or V _{IN} ≤ 0.2V, f = 0	Com.	— 10	— 10	— 15	— 10	— 15	— 10	— 15	mA

Note:

1. At f = f_{MAX}, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

CAPACITANCE⁽¹⁾

Symbol	Parameter	Conditions	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	6	pF
C _{OUT}	Input/Output Capacitance	V _{OUT} = 0V	8	pF

Note:

1. Tested initially and after any design or process changes that may affect these parameters.

READ CYCLE SWITCHING CHARACTERISTICS⁽¹⁾ (Over Operating Range)

Symbol	Parameter	-10		-12		-15		-20		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{RC}	Read Cycle Time	10	—	12	—	15	—	20	—	ns
t _{AA}	Address Access Time	—	10	—	12	—	15	—	20	ns
t _{OH}	Output Hold Time	3	—	3	—	3	—	4	—	ns
t _{ACE}	$\overline{\text{CE}}$ Access Time	—	10	—	12	—	15	—	20	ns
t _{DOE}	$\overline{\text{OE}}$ Access Time	—	5	—	6	—	7	—	9	ns
t _{HZOE} ⁽²⁾	$\overline{\text{OE}}$ to High-Z Output	—	5	—	6	0	6	0	8	ns
t _{LZOE} ⁽²⁾	$\overline{\text{OE}}$ to Low-Z Output	0	—	0	—	0	—	0	—	ns
t _{HZCE} ⁽²⁾	$\overline{\text{CE}}$ to High-Z Output	0	5	0	6	0	6	0	8	ns
t _{LZCE} ⁽²⁾	$\overline{\text{CE}}$ to Low-Z Output	3	—	3	—	3	—	3	—	ns
t _{BA}	$\overline{\text{LB}}, \overline{\text{UB}}$ Access Time	—	5	—	6	—	7	—	9	ns
t _{HZB}	$\overline{\text{LB}}, \overline{\text{UB}}$ to High-Z Output	0	5	0	6	0	6	0	8	ns
t _{LZB}	$\overline{\text{LB}}, \overline{\text{UB}}$ to Low-Z Output	0	—	0	—	0	—	0	—	ns

Notes:

1. Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1.
2. Tested with the load in Figure 2. Transition is measured ± 500 mV from steady-state voltage. Not 100% tested.
3. Not 100% tested.

AC TEST CONDITIONS

Parameter	Unit
Input Pulse Level	0V to 3.0V
Input Rise and Fall Times	3 ns
Input and Output Timing and Reference Level	1.5V
Output Load	See Figures 1 and 2

AC TEST LOADS

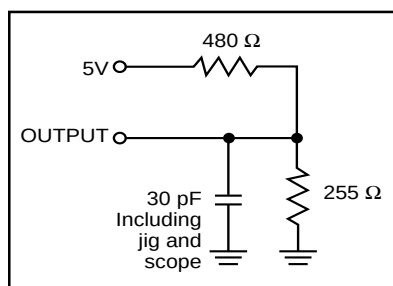


Figure 1

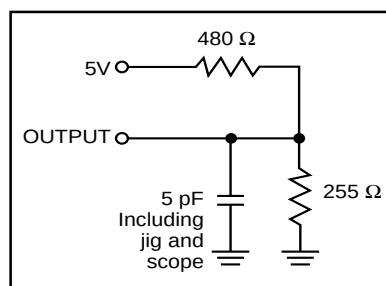
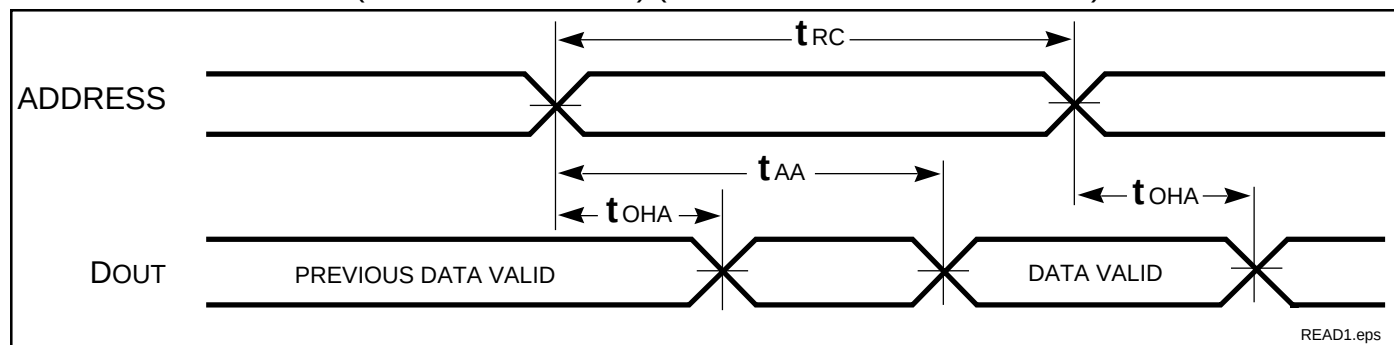
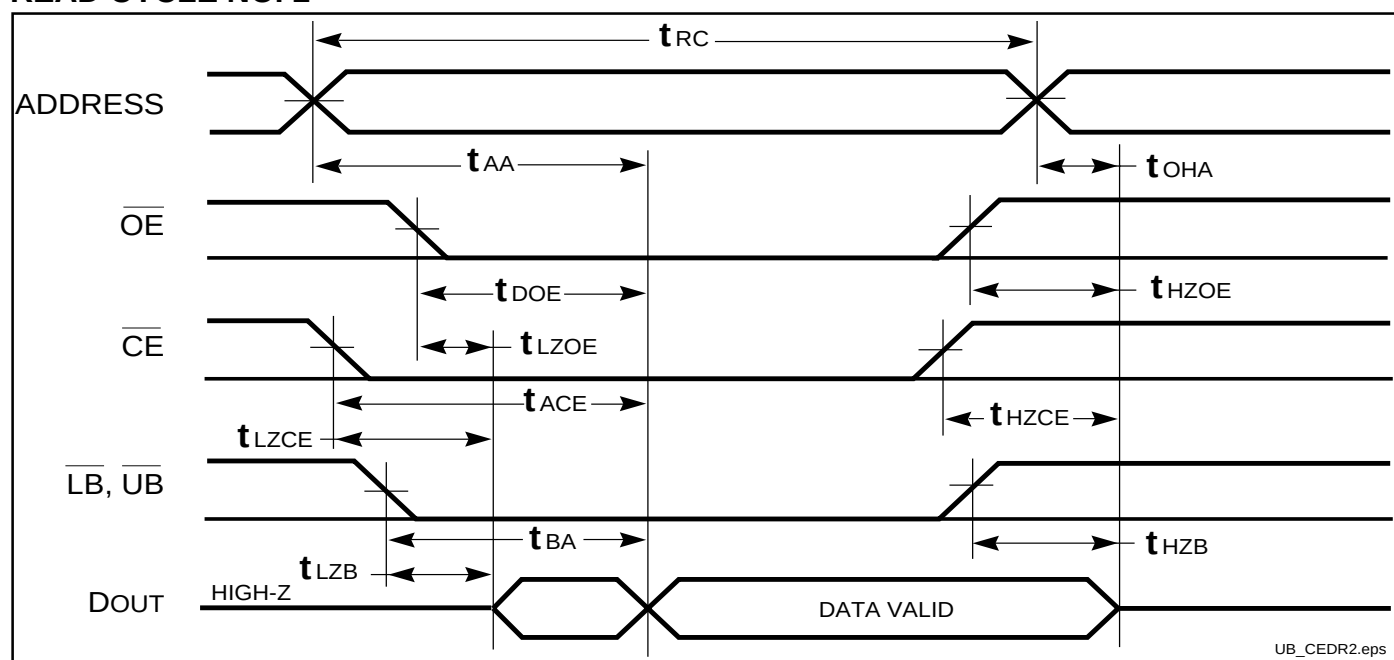


Figure 2

AC WAVEFORMS

READ CYCLE NO. 1^(1,2) (Address Controlled) ($\overline{CE} = \overline{OE} = V_{IL}$, $\overline{UB}$ or $\overline{LB} = V_{IL}$)READ CYCLE NO. 2^(1,3)

Notes:

1. $\overline{WE}$ is HIGH for a Read Cycle.
2. The device is continuously selected. $\overline{OE}$, $\overline{CE}$, $\overline{UB}$, or $\overline{LB} = V_{IL}$.
3. Address is valid prior to or coincident with $\overline{CE}$ LOW transition.

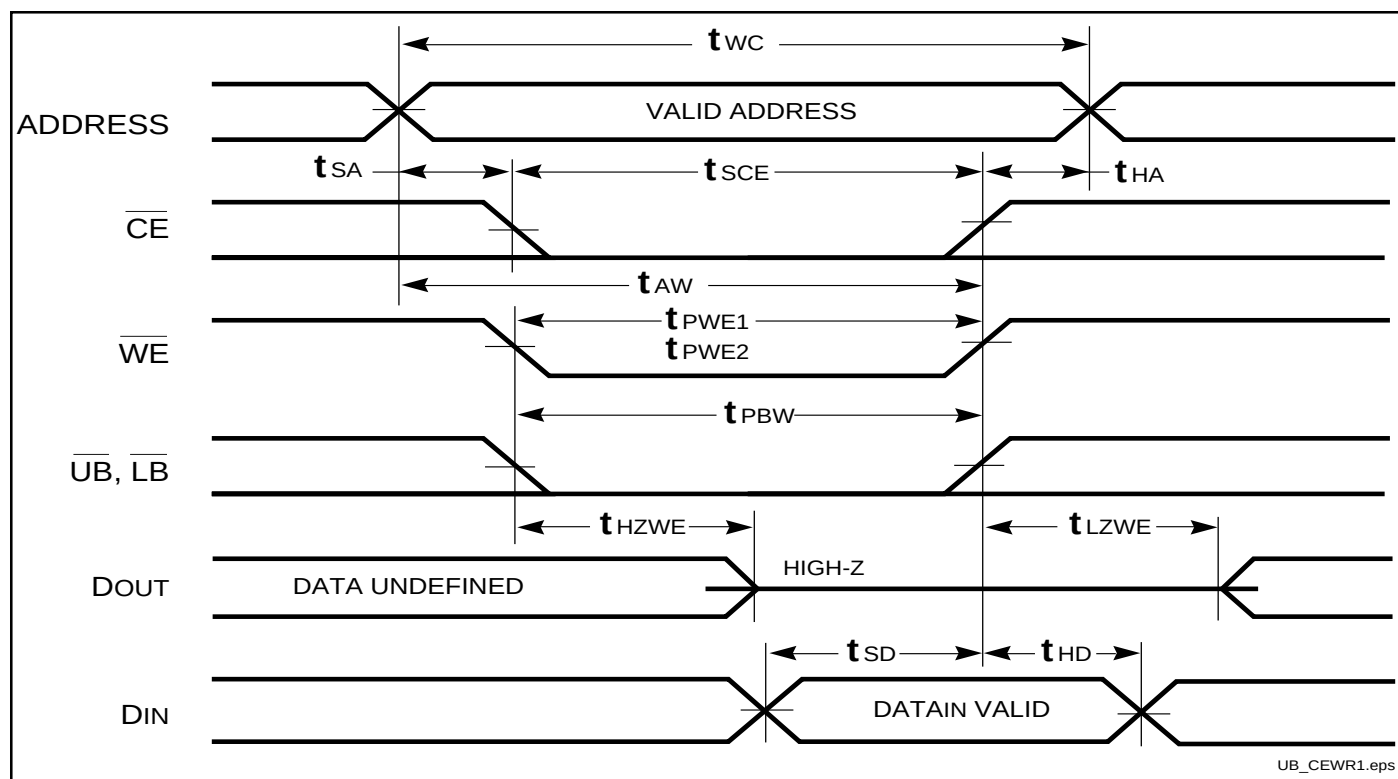
WRITE CYCLE SWITCHING CHARACTERISTICS^(1,3) (Over Operating Range)

Symbol	Parameter	-10		-12		-15		-20		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{WC}	Write Cycle Time	10	—	12	—	15	—	20	—	ns
t _{SCE}	$\overline{CE}$ to Write End	8	—	9	—	10	—	12	—	ns
t _{AW}	Address Setup Time to Write End	8	—	9	—	10	—	12	—	ns
t _{HA}	Address Hold from Write End	0	—	0	—	0	—	0	—	ns
t _{SA}	Address Setup Time	0	—	0	—	0	—	0	—	ns
t _{PWB}	$\overline{LB}$, $\overline{UB}$ Valid to End of Write	8	—	9	—	10	—	12	—	ns
t _{PWE1}	$\overline{WE}$ Pulse Width ($\overline{OE}$ =High)	8	—	9	—	10	—	12	—	ns
t _{PWE2}	$\overline{WE}$ Pulse Width ($\overline{OE}$ =Low)	8	—	9	—	10	—	12	—	ns
t _{SD}	Data Setup to Write End	6	—	6	—	7	—	9	—	ns
t _{HD}	Data Hold from Write End	0	—	0	—	0	—	0	—	ns
t _{HZWE⁽²⁾}	$\overline{WE}$ LOW to High-Z Output	—	5	—	6	—	7	—	9	ns
t _{LZWE⁽²⁾}	$\overline{WE}$ HIGH to Low-Z Output	3	—	3	—	3	—	3	—	ns

Notes:

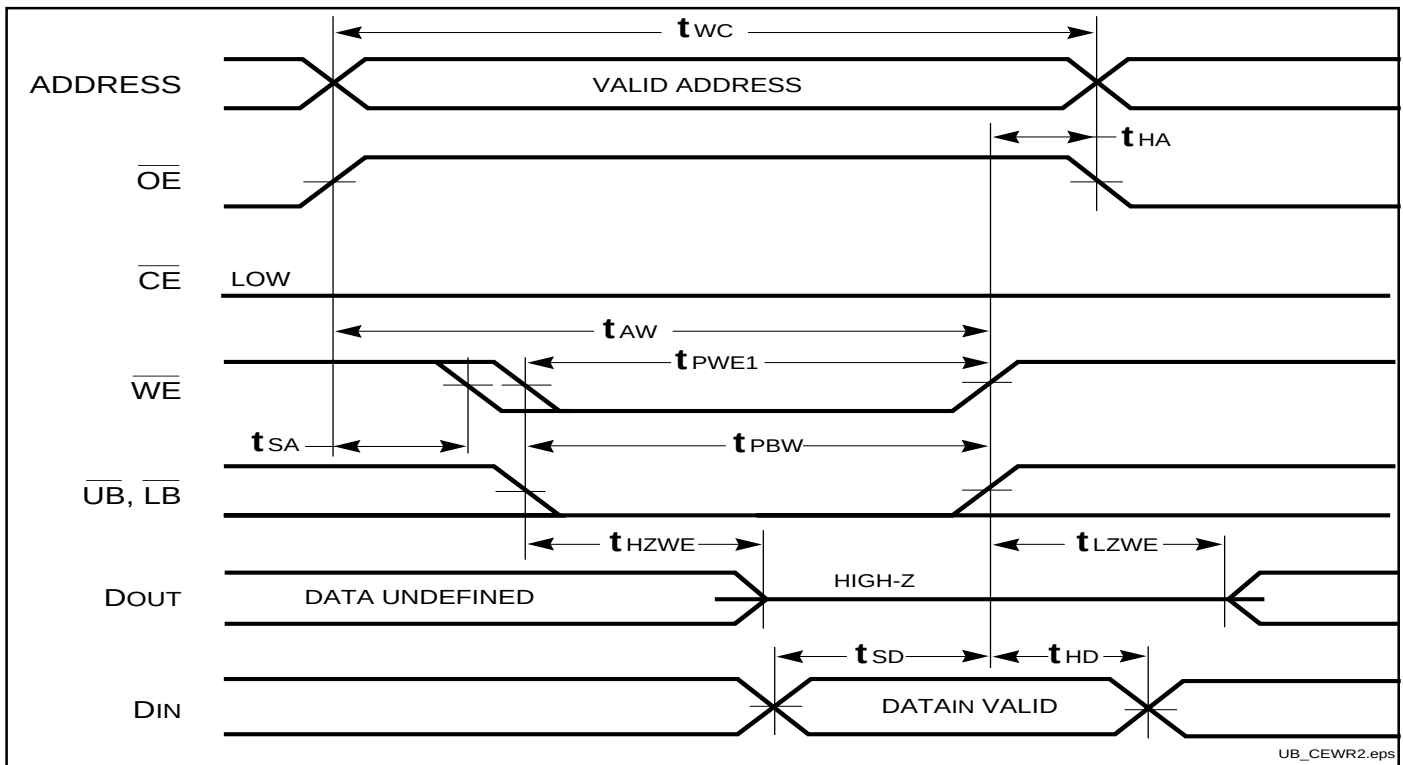
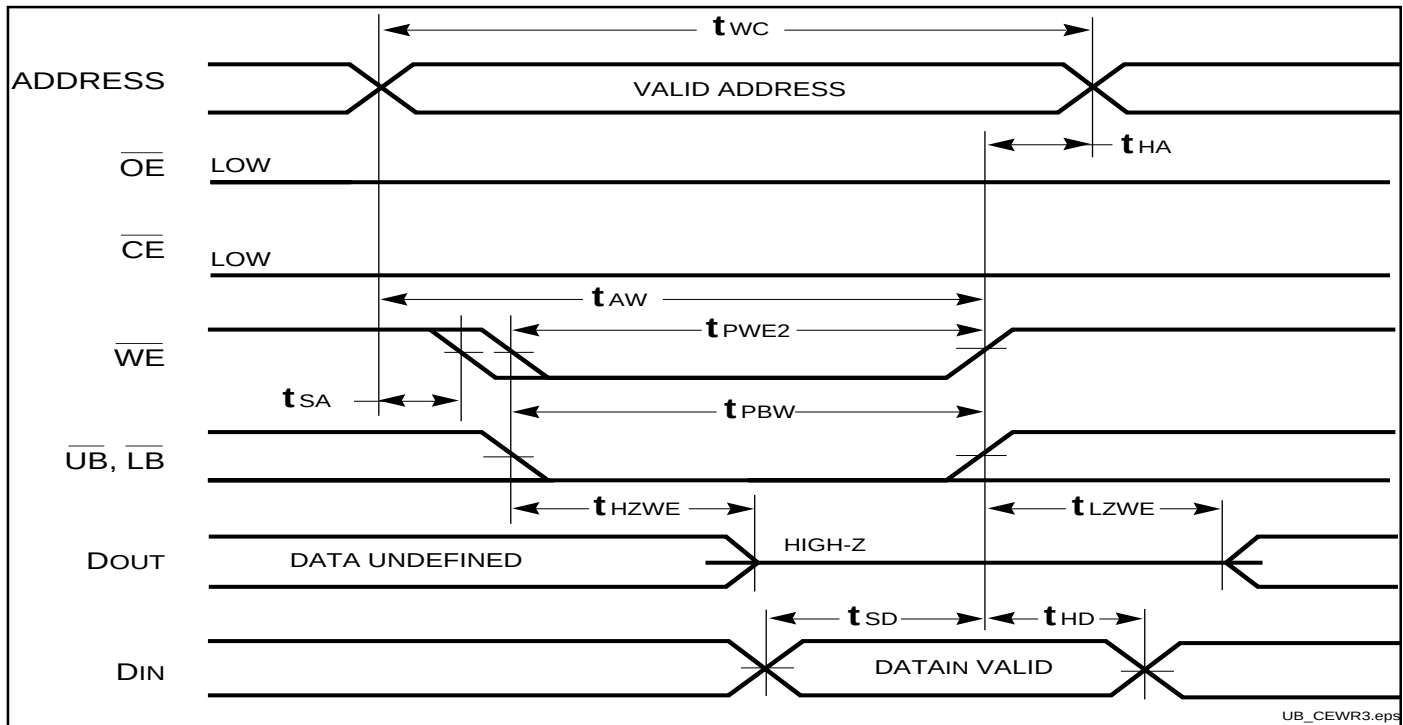
1. Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1.
2. Tested with the load in Figure 2. Transition is measured ± 500 mV from steady-state voltage. Not 100% tested.
3. The internal write time is defined by the overlap of $\overline{CE}$ LOW and $\overline{UB}$ or $\overline{LB}$, and $\overline{WE}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write.

AC WAVEFORMS

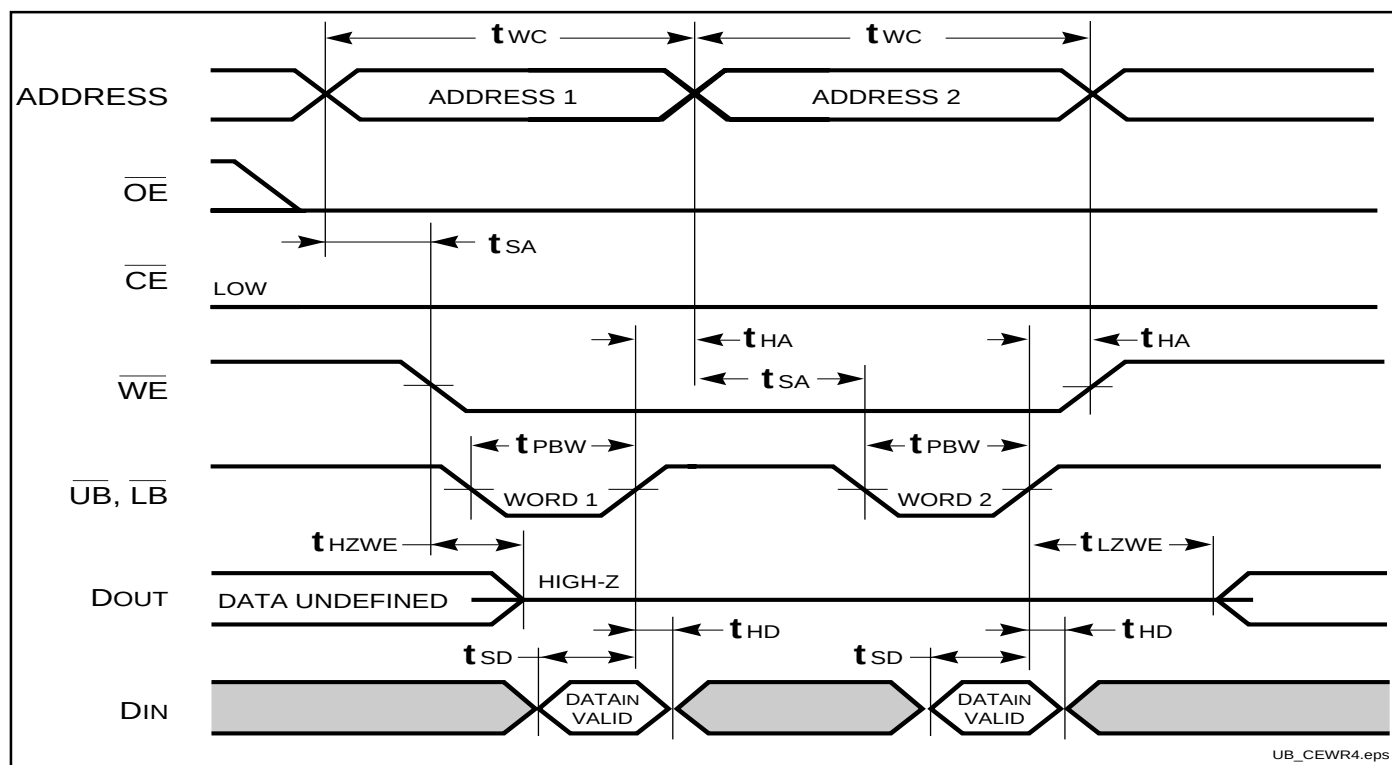
WRITE CYCLE NO. 1 ($\overline{WE}$ Controlled)^(1,2)

Notes:

1. WRITE is an internally generated signal asserted during an overlap of the LOW states on the $\overline{CE}$ and $\overline{WE}$ inputs and at least one of the $\overline{LB}$ and $\overline{UB}$ inputs being in the LOW state.
2. $WRITE = (\overline{CE}) [(\overline{LB}) = (\overline{UB})] (\overline{WE})$.

WRITE CYCLE NO. 2 ($\overline{OE}$ is HIGH During Write Cycle) ^(1,2)**WRITE CYCLE NO. 3** ($\overline{OE}$ is LOW During Write Cycle) ⁽¹⁾**Notes:**

1. The internal write time is defined by the overlap of $\overline{CE}$ LOW and $\overline{WE}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
2. I/O will assume the High-Z state if $OE \geq V_{IH}$.

WRITE CYCLE NO. 4 ($\overline{UB}/\overline{LB}$ Back to Back Write)**ORDERING INFORMATION****Commercial Range: 0°C to +70°C**

Speed (ns)	Order Part No.	Package
10	IS61C6416-10T	Plastic TSOP(II)
10	IS61C6416-10K	400-mil Plastic SOJ
12	IS61C6416-12T	Plastic TSOP(II)
12	IS61C6416-12K	400-mil Plastic SOJ
15	IS61C6416-15T	Plastic TSOP(II)
15	IS61C6416-15K	400-mil Plastic SOJ
20	IS61C6416-20T	Plastic TSOP(II)
20	IS61C6416-20K	400-mil Plastic SOJ

ORDERING INFORMATION**Industrial Range: -40°C to +85°C**

Speed (ns)	Order Part No.	Package
12	IS61C6416-12TI	Plastic TSOP(II)
12	IS61C6416-12KI	400-mil Plastic SOJ
15	IS61C6416-15TI	Plastic TSOP(II)
15	IS61C6416-15KI	400-mil Plastic SOJ
20	IS61C6416-20TI	Plastic TSOP(II)
20	IS61C6416-20KI	400-mil Plastic SOJ

ISSI®

Integrated Silicon Solution, Inc.

2231 Lawson Lane
 Santa Clara, CA 95054
 Tel: 1-800-379-4774
 Fax: (408) 588-0806
 E-mail: sales@issi.com
 www.issi.com